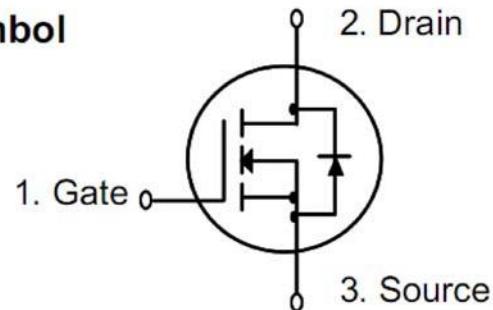


N-Channel MOSFET
Features

- $R_{DS(on)}$ (Max 0.011 Ω)@ $V_{GS}=10V$
- Gate Charge (Typical 80 nC)
- Maximum Junction Temperature Range (175 °C)

Symbol

TO-220 AB/3

Absolute Maximum Ratings

Symbol	Parameter	Value	Units
V_{DSS}	Drain to Source Voltage	80	V
I_D	Continuous Drain Current(@ $T_C = 25$ °C)	80	A
	Continuous Drain Current(@ $T_C = 100$ °C)	75	A
I_{DM}	Drain Current Pulsed	300 ^{..1)}	A
V_{GS}	Gate to Source Voltage	± 20	V
E_{AS}	Single Pulsed Avalanche Energy	1310 ^{..2)}	mJ
E_{AR}	Repetitive Avalanche Energy	17 3 ^{..1)}	mJ
dv/dt	Peak Diode Recovery dv/dt	70 ^{..3)}	V/ns
P_D	Total Power Dissipation(@ $T_C = 25$ °C)	173	W
	Derating Factor above 25 °C	1.15	W/°C
T_{STG}	Operating Junction Temperature	-55 ~ 175	°C
T_J	Storage Temperature	150	°C

Notes

^{1)..} Repeativity rating : pulse width limited by junction temperature

^{2)..} L = 0.32 mH, $I_{AS} = 75$ A, $V_{DD} = 50$ V, $R_G = 25 \Omega$, Starting $T_J = 25$ °C

^{3)..} $I_{SD} \leq 75$ A, $di/dt \leq 300$ A/us, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25$ °C

Thermal Characteristics

Symbol	Parameter	Value			Units
		Min.	Typ.	Max.	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	-	-	0.87	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient*	-	0.5	-	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	-	-	62.5	°C/W

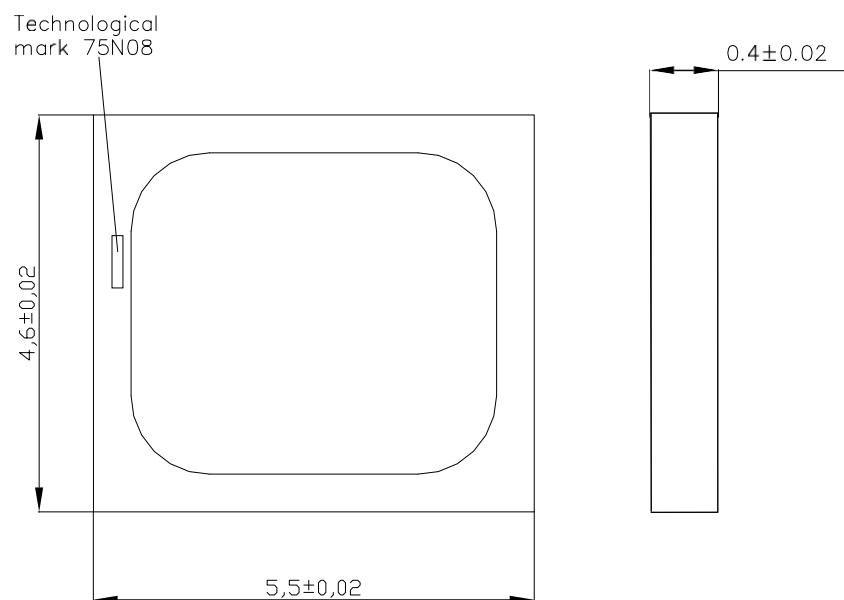
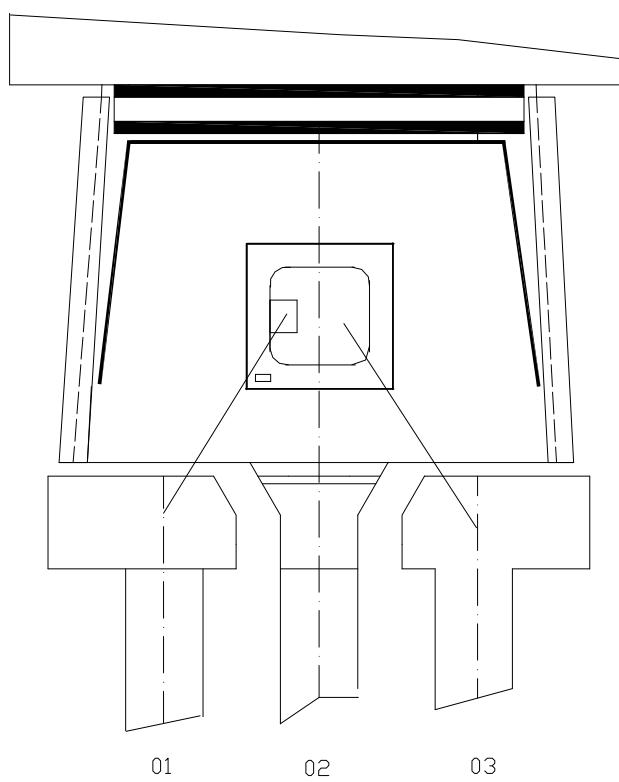
* When mounted on the minimum pad size recommended (PCB Mount)

Source-Drain Diode Characteristics and Maximum Ratings

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
I_S	Maximum Continuous Source-Drain Diode Forward Current	$I_S = 100 \text{ A}, V_{GS} = 0 \text{ V}$	-	-	80	A
I_{SM}	Maximum Pulsed Source-Drain Diode Forward Current		-	-	320	
V_{SD}	Diode Forward Voltage	-	-	1.5	-	V
t_{rr}	Reverse Recovery Time	$I_S = 100 \text{ A}, V_{GS} = 0 \text{ V}, dI/dt = 100 \text{ A/us}$	-	90	-	ns
Q_{rr}	Reverse Recovery Charge		-	250	-	uC

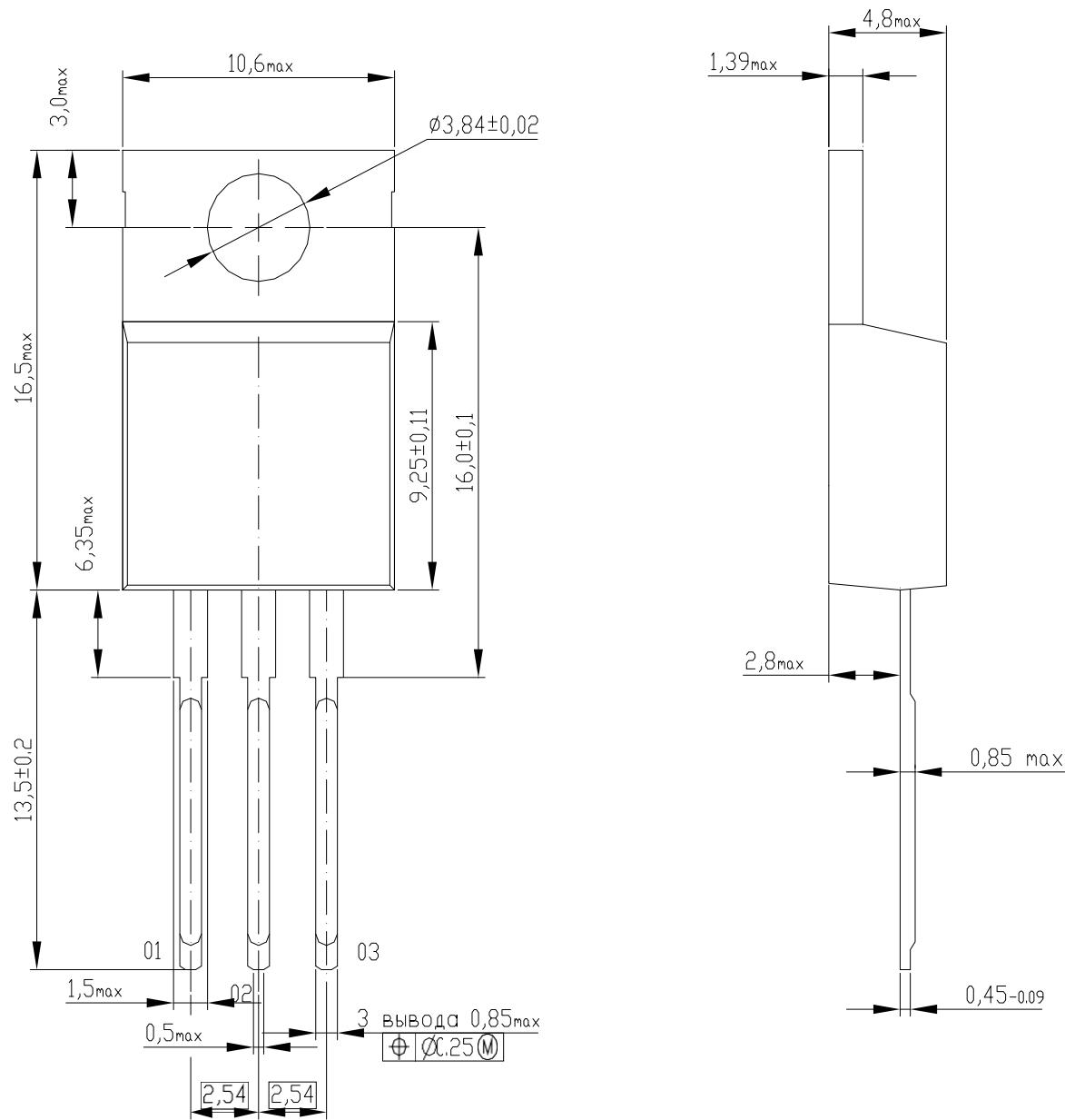
Electrical Characteristics ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}$, $I_D = 250 \mu\text{A}$	80	-	-	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	Breakdown Voltage Temperature coefficient	$I_D = 250 \mu\text{A}$, referenced to 25°C	-	0.08	-	V/ $^\circ\text{C}$
I_{DSS}	Drain-Source Leakage Current	$V_{\text{DS}} = 80 \text{ V}$, $V_{\text{GS}} = 0 \text{ V}$	-	-	10	μA
		$V_{\text{DS}} = 64 \text{ V}$, $T_C = 125^\circ\text{C}$	-	-	100	μA
I_{GSS}	Gate-Source Leakage, Forward	$V_{\text{GS}} = 20 \text{ V}$, $V_{\text{DS}} = 0 \text{ V}$	-	-	100	nA
	Gate-source Leakage, Reverse	$V_{\text{GS}} = -20 \text{ V}$, $V_{\text{DS}} = 0 \text{ V}$	-	-	-100	nA
On Characteristics						
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}$, $I_D = 250 \mu\text{A}$	2.0	-	4.0	V
$R_{\text{DS(ON)}}$	Static Drain-Source On-state Resistance	$V_{\text{GS}} = 10 \text{ V}$, $I_D = 37.5 \text{ A}$	-	-	0.008	Ω
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{\text{GS}} = 0 \text{ V}$, $V_{\text{DS}} = 25 \text{ V}$, $f = 1 \text{ MHz}$	-	2600	3380	pF
C_{oss}	Output Capacitance		-	940	1220	
C_{rss}	Reverse Transfer Capacitance		-	210	275	
Dynamic Characteristics						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}} = 40 \text{ V}$, $I_D = 100 \text{ A}$, $R_G = 25 \Omega$ Pulse Width $\leq 300\text{us}$, $Q > 50$	-	30	70	ns
t_r	Rise Time		-	225	460	
$t_{\text{d(off)}}$	Turn-off Delay Time		-	165	340	
t_f	Fall Time		-	155	320	
Q_g	Total Gate Charge	$V_{\text{DS}} = 64 \text{ V}$, $V_{\text{GS}} = 10 \text{ V}$, $I_D = 100 \text{ A}$	-	80	105	nC
Q_{gs}	Gate-Source Charge		-	15	-	
Q_{gd}	Gate-Drain Charge(Miller Charge)		-	32	-	

Chip size**Package Chip**



Package Dimensions TO-220 AB/3



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